

The TMT-HA050 hot air tool can be used for the removal of surface mount components such as SOIC, QFP, PLCC and other similar devices.

- Digital display shows temperature and air flow
- ✓ Light, portable, plug and use tool
- ✓ Uses HTN Series Hot Air Nozzles
- Convection heating allows low pressure hot air to focus on solder joints

TMT-HA050 SPECIFICATIONS

| Input Line Voltage: | 220-240 VAC | |
|-----------------------|-----------------|--|
| Power: | 600 Watts | |
| Temperature Range: | 100 °C - 480 °C | |
| Pump: | Turbine Motor | |
| Airflow (Max) | 30L / min | |
| Fuse: | 250V 3A | |
| Size (W x D): | 65mm x 265mm | |
| Weight: | 1 KG | |
| | 250 | |

CERTIFICATION MARKS PACKING LIST

| TMT-HA050 | Hot Air Tool |
|-----------|----------------------|
| HTN-D30 | Nozzle 3.0mm (0.12") |
| HTN-D50 | Nozzle 5.0mm (0.20") |
| HTN-D80 | Nozzle 8.0mm (0.31") |

CE

| HTN-D10 | Nozzle 10.0mm (0.39") |
|------------|-----------------------|
| HA-HE050-2 | Heating Element |

SC vietnam solution

